

N-Channel Enhancement Mode MOSFET

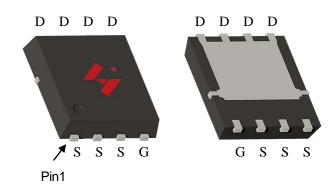
Feature

- 100V/95A $R_{DS(ON)}=4.6 \text{ m}\Omega(\text{typ.}) @V_{GS} = 10V$
- 100% Avalanche Tested
- Reliable and Rugged
- Halogen-Free Devices Available (RoHS Compliant)

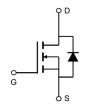
Applications

- Switching application
- Power management for inverter systems
- Battery management

Pin Description



PDFN5*6-8L



N-Channel MOSFET

Ordering and Marking Information



Package Code

C2: PDFN5*6-8L

Date Code XYMXXXXXX

Note: HUAYI lead-free products contain molding compounds/die attach materials and 100% matte tin plate Termi-Nation finish; which are fully compliant with RoHS. HUAYI lead-free products meet or exceed the lead-Free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr-oduct and/or to this document at any time without notice.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
Common Rat	tings (Tc=25°C Unless Otherwise Noted)		•	
VDSS	Drain-Source Voltage		100	V
Vgss	Gate-Source Voltage		±20	V
TJ	Junction Temperature Range		-55 to 175	°C
Tstg	Storage Temperature Range		-55 to 175	°C
Is	Source Current-Continuous(Body Diode) Tc=25°C		95	А
Mounted on	Large Heat Sink	,		•
Ірм	Pulsed Drain Current *	Tc=25°C	350	А
	Continue David Consul	Tc=25°C	95	А
lσ	Continuous Drain Current	Tc=100°C	71.5	А
D.	P _D Maximum Power Dissipation Tc:		83.3	W
PD			41.7	W
R₀JC	Thermal Resistance, Junction-to-Case		1.8	°C/W
$R_{ heta ext{A}}$	Thermal Resistance, Junction-to-Ambient **		45	°C/W
Eas	SinglePulsed-Avalanche Energy *** L=0.3mH		305	mJ

Note: * Repetitive rating; pulse width limited by max.junction temperature.
** Surface mounted on 1in2 FR-4 board.

Electrical Characteristics(Tc =25°C Unless Otherwise Noted)

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Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
Static Cha	racteristics					
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V,I _{DS} = 250μA	100	-	-	V
	Drain to Course Leakens Current	Vps= 100V,Vgs=0V	-	-	1	μA
IDSS	Drain-to-Source Leakage Current	TJ=125°C	-	-	50	μA
VGS(th)	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} = 250μA	2	3	4	V
Igss	Gate-Source Leakage Current	Vgs=±20V,Vps=0V	-	-	±100	nA
RDS(ON)	Drain-Source On-State Resistance	V _{GS} = 10V,I _{DS} =20A	-	4.6	5.3	mΩ
Diode Cha	racteristics					
VsD	Diode Forward Voltage	Isp=20A,Vgs=0V	-	0.82	1.2	V
trr	Reverse Recovery Time	lon-20	-	55	-	ns
Qrr	Reverse Recovery Charge	Isp=20A,dIsp/dt=100A/µs	-	104	-	nC

^{***} Limited by TJmax , starting TJ=25°C, L = 0.3mH, Rg= 25Ω , Vgs =10V.



Electrical Characteristics (Cont.) (Tc =25°C Unless Otherwise Noted)

Cumbal	Dovometer	Toot Conditions	HY	HYG053N10NS1		
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
Dynamic (Dynamic Characteristics					
Rg	Gate Resistance	V _{GS} =0V,V _{DS} =0V,F=1MHz	-	2.3	-	Ω
Ciss	Input Capacitance	Vgs=0V,	-	3744	-	
Coss	Output Capacitance	VDS= 25V,	-	1342	-	pF
Crss	Reverse Transfer Capacitance	Frequency=1.0MHz	-	153	-	
td(ON)	Turn-on Delay Time		-	20	-	
Tr	Turn-on Rise Time	$V_{DD}=50V,R_{G}=4.0\Omega,$	-	53	-	
td(OFF)	Turn-off Delay Time	IDS= 20A, VGS= 10V	-	58	-	ns
Tf	Turn-off Fall Time		-	47	-	
Gate Charge Characteristics						
Qg	Total Gate Charge	\/ 90\/ \/ 10\/	-	73	-	
Qgs	Gate-Source Charge	$V_{DS} = 80V, V_{GS} = 10V,$ $I_{DS} = 20A$	-	20	-	nC
Qgd	Gate-Drain Charge	1 _{DS} - 20A	-	23	-	

Note: *Pulse test, pulse width ≤ 300us, duty cycle ≤ 2%



Typical Operating Characteristics

Figure 1: Power Dissipation

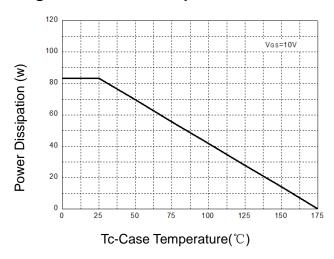


Figure 3: Safe Operation Area

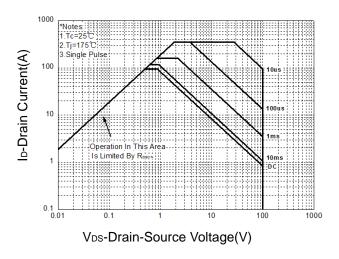


Figure 5: Output Characteristics

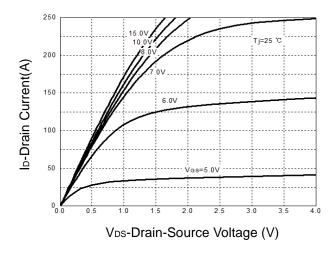


Figure 2: Drain Current

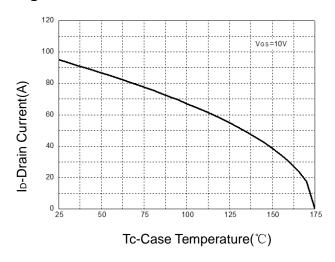
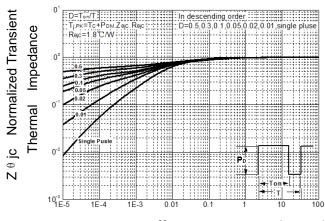
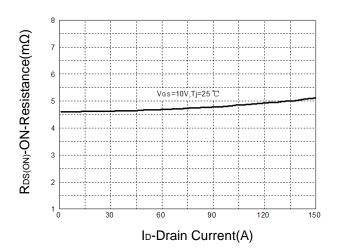


Figure 4: Thermal Transient Impedance



Maximum Effective Transient Thermal Impedance, Junction-to-Case

Figure 6: Drain-Source On Resistance





Typical Operating Characteristics(Cont.)

Figure 7: On-Resistance vs. Temperature

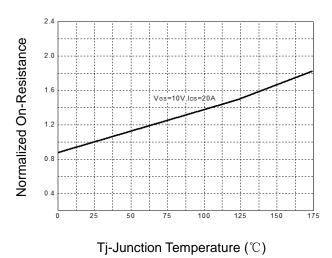


Figure 9: Capacitance Characteristics

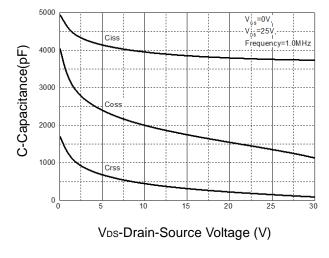


Figure 8: Source-Drain Diode Forward

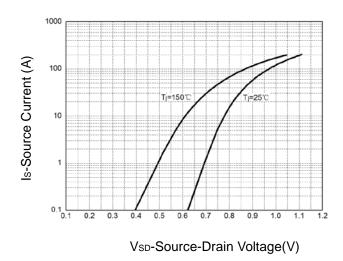
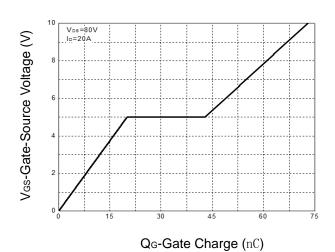
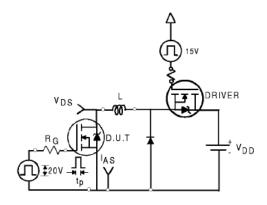


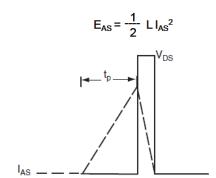
Figure 10: Gate Charge Characteristics



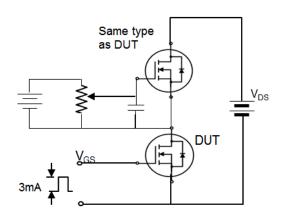


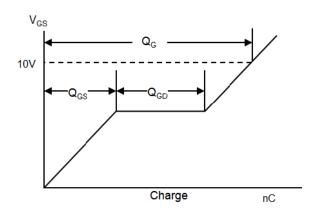
Avalanche Test Circuit



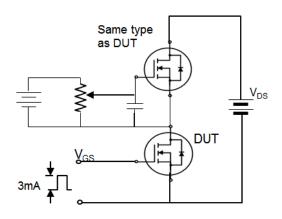


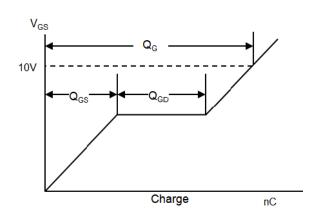
Switching Time Test Circuit





Gate Charge Test Circuit





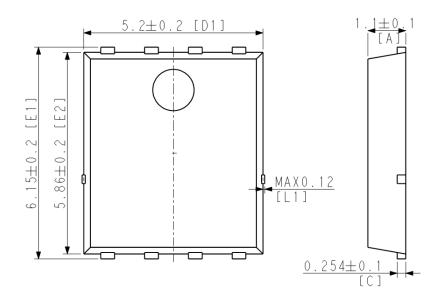


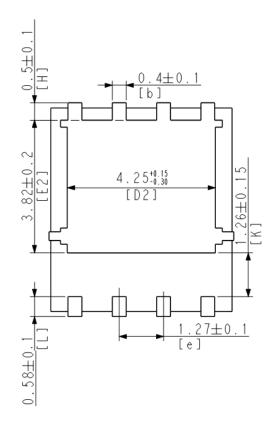
Device Per Unit

Package Type	Unit	Quantity
PDFN5*6-8L	Reel	5000

Package Information

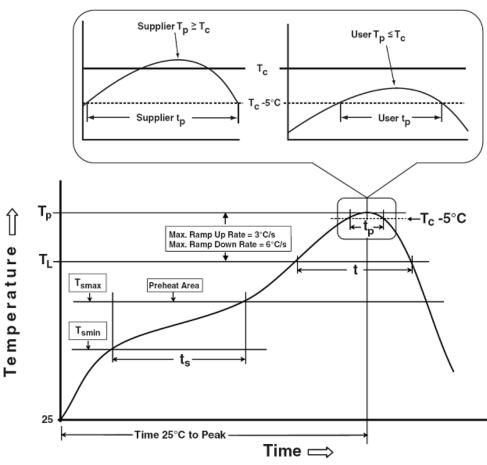
PDFN5*6-8L







Classification Profile



Classification Reflow Profiles

Sn-Pb Eutectic Assembly	Pb-Free Assembly
100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
3 °C/second max.	3°C/second max.
183 °C 60-150 seconds	217 °C 60-150 seconds
See Classification Temp in table 1	SeeClassification Tempin table 2
20** seconds	30** seconds
6 °C/second max.	6 °C/second max.
6 minutes max.	8 minutes max.
	100 °C 150 °C 60-120 seconds 3 °C/second max. 183 °C 60-150 seconds See Classification Temp in table 1 20** seconds 6 °C/second max.

^{*}Tolerance for peak profile Temperature (Tp) is defined as a supplier minimum and a user maximum.

^{**} Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

HYG053N10NS1C2



Table 1.SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm³ <350	Volume mm³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2.Pb-free Process – Classification Temperatures (Tc)

Package	Volume mm³	Volume mm³	Volume mm³
Thickness	<350	350-2000	≥2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
PRECON	JESD-22, A113	30°C/60%/192Hrs
HTRB	JESD-22, A108	168Hrs/500Hrs/1000Hrs, Bias @ 150°C
HTGB	JESD-22, A108	168 Hrs/500Hrs/1000Hrs, V _{gs} 100% @ 150°C
PCT	JESD-22, A102	96 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	250/500/1000Cycles, -55°C~150°C

Customer Service

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